TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7WPB9306FC,TC7WPB9307FC TC7WPB9306FK,TC7WPB9307FK

Low Voltage/Low Power 2-Bit Dual Supply Bus Switch

The TC7WPB9306 and TC7WPB9307 are CMOS 2-bit dual-supply bus switches that can provide an interface between two nodes at different voltage levels. These devices can be connected to two independent power supplies. VCCA supports 1.8-V, 2.5-V and 3.3-V power supplies, whereas VCCB supports 2.5-V, 3.3-V and 5.0V power supplies.

Bidirectional level-shifting is possible by simply adding external pull-up resistors between the An/Bn data lines and the $V_{\rm CCA}$ / $V_{\rm CCB}$ supplies. There is no restriction on the relative magnitude of the An and Bn voltages; both the An and Bn data lines can be pulled up to arbitrary power supplies.

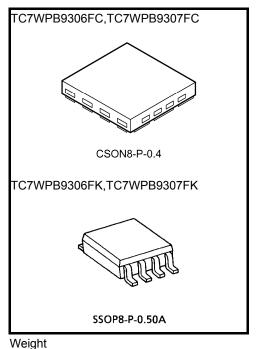
The enable signal can be used to disable the device so that the buses are effectively isolated.

The Output Enable ($\overline{\text{OE}}$:TC7WPB9307, OE:TC7WPB9306) input is common for all the two-bits of the data lines; thus these device are used as a single two-bits bus switch. For the TC7WPB9306, Output Enable (OE) is active-High: When OE is High, the switch is on; when Low, the switch is off. For the TC7WPB9307, Output Enable ($\overline{\text{OE}}$) is active-Low: When $\overline{\text{OE}}$ is Low, the switch is on; when High, the switch is off.

The TC7WPB9306 and TC7WP9307 supports power-down protection at the \overline{OE} ,OE input, with \overline{OE} ,OE being 5.5-V tolerant.

The channels consist of n-type MOSFETs.

All the inputs provide protection against electrostatic discharge.



CSON8-P-0.4 : 0.002 g (typ.) SSOP8-P-0.50A : 0.01 g (typ.)

Features

- Operating voltage:1.8-V to 2.5-V, 1.8-V to 3.3-V, 1.8-V to 5.0-V, 2.5-V to 3.3-V, 2.5-V to 5.0-V or 3.3-V to 5.0-V bidirectional interface
- Operating voltage: $V_{CCA} = 1.65$ to 5.0 V, $V_{CCB} = 2.3$ to 5.5 V
- Low ON-resistance: $R_{ON} = 5.0 \Omega$ (typ.)

(ON-resistance test circuit: VIS = 0 V, IIS = 30 mA, VCCA= 3.0 V, VCCB = 4.5 V)

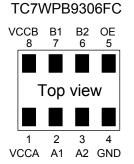
• ESD performance: Machine model ≥ ±200 V

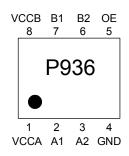
Human body model $\geq \pm 2000 \text{ V}$

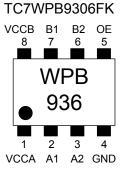
- 5.5-V tolerance and power-down protection at the Output Enable input.
- Packages: CST8,US8

Pin Assignment (top view)

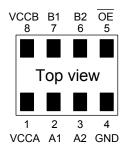


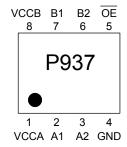




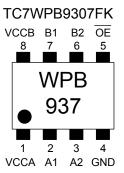


TC7WPB9307FC





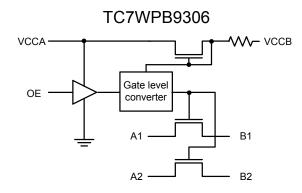
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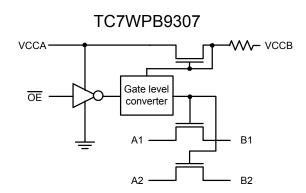


Truth Table

Inputs(9306)	Function	Inputs(9307)	Function		
OE	i dilodori	ŌE	1 unction		
L	Disconnect	L	A port = B port		
Н	H A port = B port		Disconnect		

Circuit Schematic







Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CCA}	-0.5 to 7.0	V
Tower supply voltage	V _{CCB}	-0.5 to 7.0	٧
Control input voltage	V _{IN}	-0.5 to 7.0	٧
Switch input/output voltage	Vs	-0.5 to 7.0	٧
Clump diode current	l _{IK}	-50	mA
Switch input/output current	IS	64	mA
DC V _{CC} /ground current per supply pin	I _{CCA}	±25	mA
De veeground current per supply pin	I _{CCB}	±25	
Power dissipation	PD	150(CSON8)	mW
rowei dissipation	гD	200(SSOP8)	11100
Storage temperature	T _{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V _{CCA}	1.65 to 5.0	V	
(Note 2)	V _{CCB}	2.3 to 5.5	v	
Control input voltage	V _{IN}	0 to 5.5	V	
Switch input/output voltage	V _S	0 to 5.5	V	
Operating temperature	T _{opr}	-40 to 85	°C	
Control input rise and fall times	dt/dv	0 to 10	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs and bus inputs must be tied to either $V_{\mbox{\scriptsize CCA}}$ or GND.

Note 2: The V_{CCA} voltage must be lower than the V_{CCB} voltage.

Application Circuit

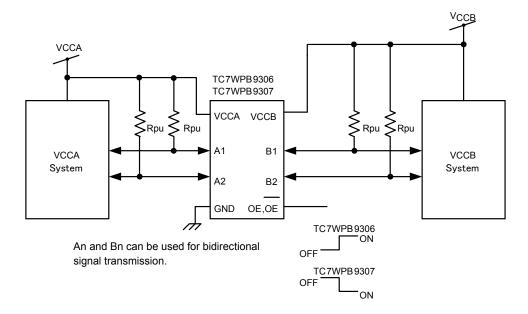


Figure 1 Application Circuit Diagram

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The V_{CCA} voltage must be lower than the V_{CCB} voltage.

Level-shifting functionality is enabled by adding pull-up resistors from An to V_{CCA} or V_{CCB} and from Bn to V_{CCB} or V_{CCA} , respectively.



Electrical Characteristics

DC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics		Symbol	Test Condition	V _{CCA} (V)	V _{CCB} (V)	Ta = -40 to 85°C		Unit	
						Min	Max		
	High-level	V _{IH}		1.65 ≤ V _{CCA} < 2.3	V _{CCA} to 5.5	0.8× V _{CCA}	_		
Control input	i ligit-level	VIH	_	2.3 ≤ V _{CCA} < 5.0	V _{CCA} to 5.5	0.7× V _{CCA}		V	
voltage	Low-level	V _{IL}		1.65 ≤ V _{CCA} < 2.3	V _{CCA} to 5.5	_	0.2× V _{CCA}	V	
	Low-level	V IL		$2.3 \le V_{CCA} < 5.0$	V _{CCA} to 5.5	_	0.3× V _{CCA}		
				1.65	2.3	_	16.0		
ON-resistance (Note)	RON	$V_{IS} = 0 \text{ V}, I_{IS} = 30 \text{ mA}$ (Figure 2)	2.3	3.0	_	11.0	Ω		
			(. iguio 2)	3.0	4.5	_	8.0		
Power off leakage current		l _{OFF}	An,Bn=0 to 5.5 V (per circuit)	0	0	_	±1.0	μА	
Switch-off leakage current		I _{SZ}	An,Bn=0 to 5.5 V $\overline{OE} = V_L$,OE=GND	1.65 to 5.0	V _{CCA} to 5.5	_	±1.0	μА	
Control input of	urrent	I _{IN}	OE = 0 to 5.5V	1.65 to 5.0	V _{CCA} to 5.5	_	±1.0	μΑ	
leakage current form V _{CCB} to V _{CCA}		I _{CCBA}	OE = 0 or V _{CCA} V _{CCB} →V _{CCA}	3.3	5.0	_	10.0	μΑ	
Icc		I _{CCA1}	$\overline{OE} = V_{CCA}$ or GND, I _S =0 A	1.65 to 5.0	V _{CCA}		1.0		
Quiescent sup	nly current	I _{CCB1} \overline{OE} = V _{CCA} or GND, I _S =0 A		1.65 to 5.0	V_{CCA}	_	1.0	μА	
Quicocont Sup	p., ourroint	I _{CCA2}	$V_{CCA} \le \overline{OE} \le 5.5 \text{ V, I}_S = 0 \text{ A}$	1.65 to 5.0	V_{CCA}		±1.0	μΑ	
		I _{CCB2}	$V_{CCA} \le \overline{OE} \le 5.5 \text{ V}, I_S=0 \text{ A}$	1.65 to 5.0	V_{CCA}	_	±1.0		

Note: ON-resistance is measured by measuring the voltage drop across the switch at the indicated current.

Level Shift Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition	V _{CCA} (V)	V _{CCB} (V)	Ta = -40 to 85°C		Unit
					Min	Max	
Input/Output Characteristics		An = V _{IN}	1.65	3.0 to 5.5	1.4	_	
(Up Translation) V _{OHU}		SW = ON	2.3	4.5 to 5.5	2.05	_	
(Note 1)		(Figure 7)	3.0	4.5 to 5.5	2.7	_	\ /
Input/Output Characteristics		An = V _{CCA}	1.65	3.3 to 5.5	1.3	1.65	V
(Down Translation)	own Translation) V _{OHD}		2.3	4.5 to 5.5	1.95	2.3	
(Note 2)		(Figure 9)	3.0	4.5 to 5.5	2.6	3.0	

Note 1: The Input/Output Characateristics for up translation indicate the input voltages required to provide $V_{CCA} + 0.5 \text{ V}$ on the outputs when measured using the test circuitry shown in Figure 7.

Note 2: The Input/Output Characateristics for down translation indicate the voltages that cause the output voltages to saturate when measured using the test circuitry shown in Figure 9.



AC Characteristics (Ta = -40 to 85°C, Input: $t_r = t_f = 2.0$ ns,f=10kHz)

 $V_{CCA} {= 3.3 \pm 0.3 \text{ V}, \, V_{CCB} {= 5.0 \pm 0.5 \text{ V}}}$

Characteristics	Symbol	Test Condition		Min	Max	Unit
Propagation delay time (Bus to Bus)	t _{pLH}	Figures 3 and 5	(Note)	_	0.3	
Propagation delay time (Bus to Bus)	t _{pHL}	Figures 3 and 5	(Note)	_	1.2	ns
Output enable time	t _{pZL}	Figures 4 and 6		_	9.0	
Output disable time	t _{pLZ}	Figures 4 and 6			11.0	

Note: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 30 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

 $V_{CCA} \!\!= 2.5 \pm 0.2$ V, $V_{CCB} \!\!= 5.0 \pm 0.5$ V

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time (Bus to Bus)	t _{pLH}	Figures 3 and 5 (Note)	_	0.35	
Propagation delay time (Bus to Bus)	t _{pHL}	Figures 3 and 5 (Note)	_	1.8	ns
Output enable time	t _{pZL}	Figures 4 and 6	_	13.0	
Output disable time	t _{pLZ}	Figures 4 and 6	_	15.0	

Note: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 30 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

 $V_{CCA} = 2.5 \pm 0.2$ V, $V_{CCB} = 3.3 \pm 0.3$ V

Characteristics	Symbol	Test Condition		1in	Max	Unit
Propagation delay time (Bus to Bus)	t _{pLH}	Figures 3 and 5 (No	ote) -	_	0.45	
Propagation delay time (Bus to Bus)	t _{pHL}	Figures 3 and 5 (No	ote) -	_	2.2	ns
Output enable time	t _{pZL}	Figures 4 and 6	-		17.0	
Output disable time	t_{pLZ}	Figures 4 and 6	-	_	19.0	

Note: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 30 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

Capacitive Characteristics (Ta = 25°C)

Characteristics	Cumbal	Symbol Test Condition				
Characteristics	Symbol	rest Condition	V _{CCA} (V)	V _{CCB} (V)	Тур.	Unit
Control input capacitance	C _{IN}		3.3	3.3	3	
Switch input/output capacitance	Cuo	SW=ON	3.3	3.3	14	pF
Switch input/output capacitance	C _{I/O}	SW=OFF	3.3	3.3	7	

DC Test Circuit

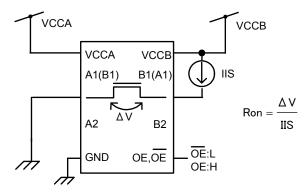


Figure 2 ON-resistance Test Circuits

AC Test Circuits

• tpLH,HL

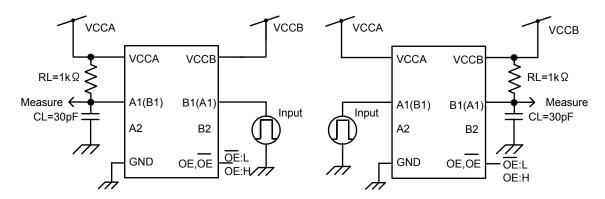


Figure 3 tpLH, tpHL Test Circuits

• tpLZ,ZL

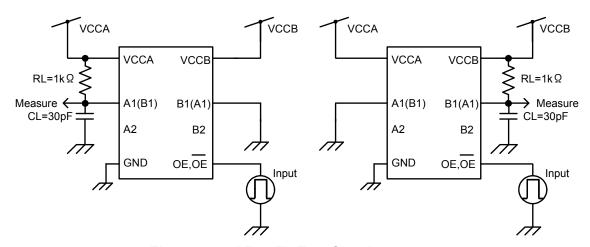


Figure 4 tpLZ, tpZL Test Circuits

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AC Waveform

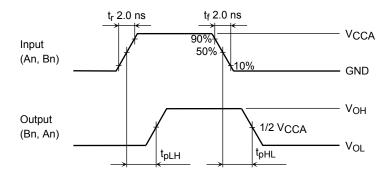


Figure 5 tpLH, tpHL

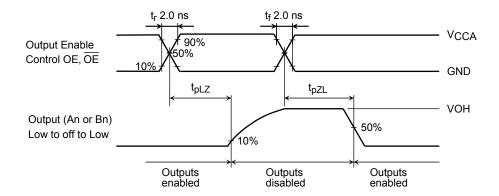


Figure 6 tpLZ, tpZL

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Level Shift Function (Used Pull-up Resistance)

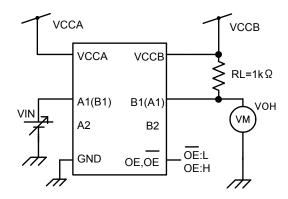
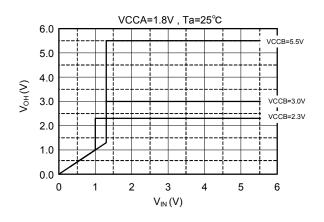
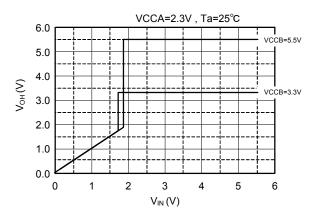


Figure 7 Test Circuit





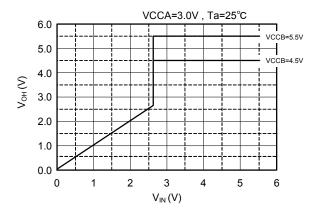


Figure 8 Input/Output Characteristics (Typ.)



Level Shift Function (Unused Pull-up Resistance)

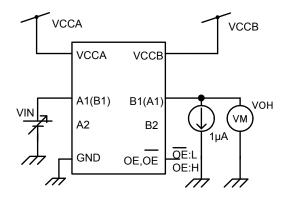
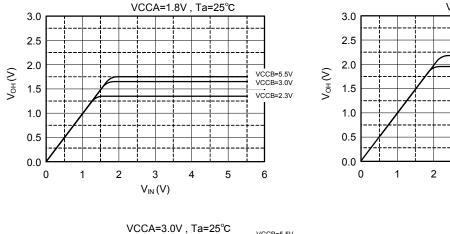
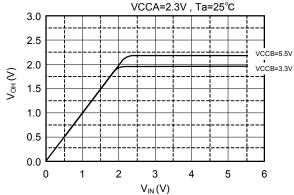


Figure 9 Test Circuit





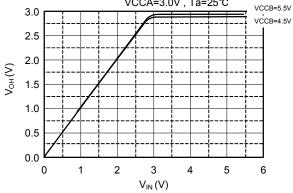
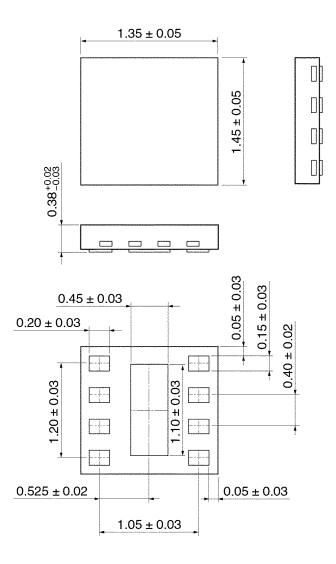


Figure 10 Input/Output Characteristics (Typ.)

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Package Dimensions

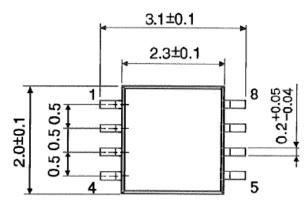
CSON8-P-0.4 Unit: mm

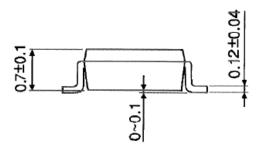


Weight: 0.002 g (typ.)

Package Dimensions

SSOP8-P-0.50A Unit: mm





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Weight: 0.01 g (typ.)



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